

ExaMAX® IO Connector System

ExaMAX® VS I/O system offers cable assemblies and I/O connector solutions for both internal and external applications. ExaMAX® I/O products are capable of delivering high speed performance of 25 Gb/s per channel with a path to 40 Gb/s and higher. The ExaMAX® I/O system delivers superior linear board signal density and meets the performance requirements of the OIF-CEI-25G-LR industry standard.

The internal I/O system is offered in both cabled backplane and point-to-point internal cables that feature positive latching and integrated guidance to ensure a robust interconnection. The internal system is designed as a direct replacement for a vertical header connector on a backplane and/or midplane using hard metric design guidelines. Flyover applications can be designed to attach to QSFP, SlimSAS, Slim Cool Edge and other connectors for customer-specific applications.

The external cable system features robust metal die castings in various exit configurations coupled with a braided shield and EMI gasket system to assure reliable EMI performance. Jackscrew mechanical mounting provides robust and flexible strain relief solutions.

Amphenol Cable Backplane Systems is able to create custom cabling solutions and configurations to meet specific design requirements. The ExaMAX® I/O system is highly scalable and modular and has the ability to fit in almost any application.

FEATURES

- Capable of supporting 25Gb/s data rates with a scalable migration path to 40Gb/s
- Revolutionary beam-on-beam contact interface
- Hermaphroditic mating interface protects mating beams
- Efficient 92Ω design
- Internal & external IO systems
- Modular & scalable design
- Engineered wire management & termination
- Utilizes either ribbonized or individual twin-axial cable
- Integration of float, alignment and keying all in one system
- Extra pins available for applications needing low speed/diagnostic signals



BENEFITS

- Supports present and future data rate bandwidth needs without costly re-design or re-qualification
- Superior signal integrity performance due to minimized stub and impedance control; 40% lower mating force
- Durable, reliable and protected interface eliminates pin stubbing/ crushing
- Allows for support of both 85 and 100 Ω systems
- Addresses IO needs whether for inside the box or outside the box cabling applications
- Enables designers to accommodate varying signal pair counts using different product configurations
- Impedance maintained and cross talk minimized in the wire termination area
- Accommodates either planar or single differential pair cable construction across different AWG wire sizes
- Address system tolerances, blind mating and proper keying considerations
- Offers designers the option to add low speed signaling when required with no major revisions needed to the IO system

TECHNICAL INFORMATION

MATERIAL

- Contacts: High performance Copper Alloy
- Plating(s): Performance-based plating at separable interface (Telcordia GR-1217-CORE)
 Tin over Nickel on press-fit tails
- Housings: High Performance Thermoplastic, UL94-V0
- Raw Cable: Ag plated copper conductors with foam insulation covered by conductive foil

MECHANICAL PERFORMANCE

- Mating Force: 0.36 N max. per contact
- Unmating Force: 0.12 N min. per contact
- Press-fit Insertion Force: 15 N max. per contact
- X and Y gatherability of ±1.4 mm
- Cable Strain Relief: 100 N min. when axial load is applied directly to cable
- Panel Retention Frame: 120 N min. when axial load applied to cable latched in frame

ELECTRICAL PERFORMANCE

- Contact Resistance: 10 m max change from initial reading
- Current Rating (less than 30°C temperature rise above ambient): signal contact: 0.50 Amps/ contact – ground contact: 2 Amps/contact
- Operating Voltage: 50 VAC RMS

APPROVALS AND CERTIFICATIONS

- EIA 364: Electrical Connector/Socket Test Procedures Including Environmental Classifications
- IEC 60512: Connectors for Electronic Equipment –Tests and Measurement

ENVIRONMENTAL

 Telcordia GR-1217-CORE Central Office qualification pending

SPECIFICATION

- Amphenol Product Specification: GS-12-1184
- Amphenol Application Specification: GS-20-0361

PACKAGING

• Cable Packaging Specification: GS-14-1272

TARGET MARKETS/APPLICATIONS



Optical Transport Router Switches Wireless Infrastructure



External Storage System Server Supercomputer

PART NUMBERS

Product Variation				Cable Housing		
Pairs	Columns	Differential Pairs	Mating Board Connector	Guide Module	Туре	Frame or Shroud
2	20	40	10124414-101LF	No Guide	Latched w/shroud	10135766-120LF
4	8	32	10131405-201LF	Dual-guide	Panel Mounted	10131414-101LF
	8	32	10137002-12JLF	Left-guide	Panel Mounted	10127037-101LF
	10	40	10137004-12JLF	Left-guide	Panel Mounted	10131981-101LF
	4	16	10139215-101LF	No Guide	Screw Flange	10138449-001
6	8	48	10131762-12JLF	Left-guide	Panel Mounted	10133122-101LF
	10	60	10131764-12JLF	Left-guide	Panel Mounted	10141681-101LF
	8	48	10129470-102LF	No Guide	Direct Attach	N/A
	12	72	10131766-101LF	No Guide	Die Cast Frame	10137678-001

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Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

FCI / Amphenol:

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  10126226-A01002JLF
  10126226-A03002JLF
  10127037-101LF
  10126213-A00502JLF
  10126213-A03002JLF

  10126213-A01002JLF
  10126213-A02002JLF
  10126213-A01502JLF
  10129953-B00502JLF
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